
HB56D136 Series

1,048,576-word \times 36-bit High Density Dynamic RAM Module

HITACHI

Description

The HB56D136 is a 1-M \times 36-bit dynamic RAM module, mounted 8 pieces of 4 Mbit DRAM (HM514400CS/CLS) sealed in SOJ package and 2 pieces of 2 Mbit DRAM (HM512200BS/BLS) sealed in SOJ package. An outline of the HB56D136 is 72-pin single in-line package.

Therefore, the HB56D136 makes high density mounting possible without surface mount technology. The HB56D136 provides common data inputs and outputs. Decoupling capacitors are mounted beneath each SOJ.

Features

- 72-pin
 - Lead pitch: 1.27 mm
- Single 5 V ($\pm 5\%$) supply
- High speed
 - Access time: 60 ns/70 ns/80 ns (max)
- Low power dissipation
 - Active mode: 5.46 W/4.94 W/4.41 W (max)
 - Standby mode: 105 mW (max)
5.25 mW (max) (L-version)
- Fast page mode capability
- 1,024 refresh cycle: 16 ms
128 ms (L-version)
- 3 variations of refresh
 - $\overline{\text{RAS}}$ only refresh
 - CAS-before- $\overline{\text{RAS}}$ refresh
 - Hidden refresh
- TTL compatible

HB56D136 Series

Ordering Information

Type No.	Access Time	Package	Contact Pad
HB56D136BW-6C	60 ns	72-pin SIP socket type	Gold
HB56D136BW-7C	70 ns		
HB56D136BW-8C	80 ns		
HB56D136BW-6CL	60 ns	72-pin SIP socket type	Solder
HB56D136BW-7CL	70 ns		
HB56D136BW-8CL	80 ns		
HB56D136SBW-6C	60 ns	72-pin SIP socket type	Solder
HB56D136SBW-7C	70 ns		
HB56D136SBW-8C	80 ns		
HB56D136SBW-6CL	60 ns	72-pin SIP socket type	Solder
HB56D136SBW-7CL	70 ns		
HB56D136SBW-8CL	80 ns		

Note: The specification of this device is subject to change without notice. Please contact your nearest Hitachi's Sales Dept. regarding specification.